AMC741

Tilera GX72 Processor, 72 Core, Mid-size, AMC



Key Features

- Tilera™ GX72CPU with 72 Tile-Gx Core processors
- Double module, mid-size per AMC.0
- Four banks of DDR3 w/ ECC (up to 64 GB)
- AMC Ports 4-11 are routed to Tilera per AMC.2 (PCIe and XAUI options)
- AMC Ports 17-20 optionally routed as XAUI to the Tilera
- Four 10GbE to front panel
- IPMI 2.0 compliant

Benefits

- High performance with 72 processor cores (tiles) on Tilera™ chipset
- High bandwidth front-panel and backplane connectivity
- QoS queuing and traffic shaping support
- Strong mil/aero support
- Electrical, mechanical, software, and system-level expertise in house
- Full system supply from industry leader
- AS9100 and ISO9001 certified company





THE POWER OF VISION

AMC741

The AMC741 is ideal for packet filtering, intelligent networking, multimedia, video transcoding, cloud and other applications. The device includes 72 identical processor cores (tiles) interconnected with Tilera's iMesh[™] on-chip network.

Each tile consists of a full-featured, 64-bit processor core as well as L1 and L2 cache and a non-blocking Terabit/sec switch. The high processing density and high internal bandwidth of the GX72CPU make it ideal for intensive computing tasks.

The AMC741 provides four 10GbE front-panel ports via LC style connectors, making it suitable for network-centric sensor processing applications. The unit includes IEEE 1588v2 precision timing controller support, which provides precision 1 ns granularity packet timestamping for signal encoding.

The AMC741 is available in mid-size AMC for compact integration into a 1U chassis.



Figure 1: AMC741

Block Diagram

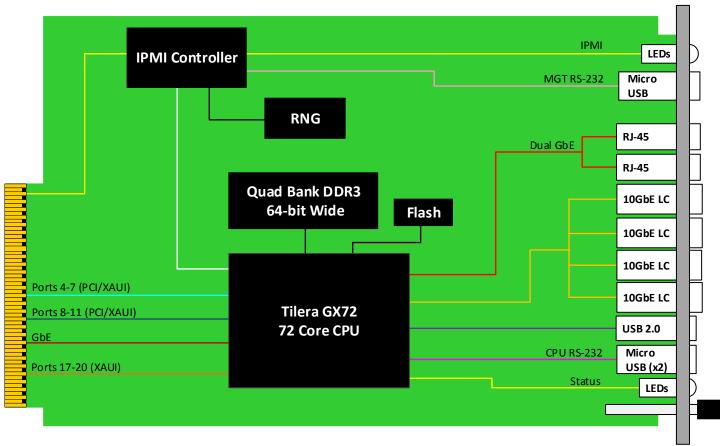


Figure 2: AMC741 Functional Block Diagram

Specifications

Architecture			
Physical	Dimensions	Width: 5.85" (148.5 mm)	
		Depth: 7.11" (180.6 mm)	
Туре	AMC Processor	72-core Tilera GX72 Processor AMC	
Standards			
AMC	Туре	AMC.0, AMC.1 and AMC.2	
Module Management	IPMI	IPMI v2.0	
Configuration			
Power	AMC741	80W	
Environmental	Temperature	See Ordering Options and Environmental Spec Sheet	
		Storage Temperature: -40° to +90°C	
		Chassis dependent	
	•	5 to 95% non-condensing	
Front Panel	Interface Connectors		
		4x LC connectors for 10GbE	
		3x Micro USB for RS-232	
		1x Mini USB for USB 2.0	
		IPMI, activity and GPIO	
		Hot swap ejector handle	
Software Support	Operating System	Linux (consult VadaTech for other options)	
Other			
MTBF	MIL Hand book 217-F@ TBD hrs		
Certifications	Designed to meet FCC, CE and UL certifications, where applicable		
Standards	VadaTech is certified to both the ISO9001:2000 and AS9100B:2004 standards		
Warranty	Two (2) years, see <u>VadaTech Terms and Conditions</u>		

INTEGRATION SERVICES AND APPLICATION-READY PLATFORMS

VadaTech has a full ecosystem of OpenVPX, ATCA and MTCA products including chassis platforms, shelf managers, AMC modules, Switch and Payload Boards, Rear Transition Modules (RTMs), Power Modules, and more. The company also offers integration services as well as preconfigured Application-Ready Platforms. Please contact VadaTech Sales for more information.

Ordering Options

AMC741 - A0C-D0F-00J

A = 10GbE on Ports 17-20	D = DDR3 Memory with ECC	
0 = Not connected 1 = Connected	0 = 16 GB 1 = 32 GB 2 = 64 GB*	
C = Front Panel Size	F = PCle Option	J = Temperature Range and Coating
1 = Reserved 2 = Mid-size 3 = Full-size (6 HP)	0 = No PCIe 1 = PCIe on Ports 4-7 2 = PCIe on Ports 8-11 3 = PCIe on Ports 4-11	0 = Commercial (-5° to +55°C), No coating 1 = Commercial (-5° to +55°C), Humiseal 1A33 Polyurethane 2 = Commercial (-5° to +55°C), Humiseal 1B31 Acrylic 3 = Industrial (-20° to +70°C), No coating 4 = Industrial (-20° to +70°C), Humiseal 1A33 Polyurethane 5 = Industrial (-20° to +70°C), Humiseal 1B31 Acrylic 6 = Extended (-40° to +85°C), Humiseal 1A33 Polyurethane** 7 = Extended (-40° to +85°C), Humiseal 1B31 Acrylic**

Notes: *Minimum order quantity required.

**Conduction cooled; temperature is at edge of module. Consult factory for availability

Related Products



- Unified 1 GHz quad-core CPU for MCMC, Shelf Manager, Clocking, and Fabric management
- Automatic fail-over with redundant UTC004s
- Full Layer 2 or 3 managed Ethernet switches



- 19" x 8U x 14.9" deep (with handles 16.23" deep)
- Full redundancy with dual MicroTCA Carrier Hubs (MCH), dual cooling units and quad PSUs
- Up to twelve AMCs: 12 mid-size double modules in front with 12 mid-size, double-module in the rear
- MTCA System Platform 5" x 7U x 9" deep
- Redundant Cooling Units
- Up to six AMCs: 6 full-size single or 3 full-size double modules





Contact

VadaTech Corporate Office

198 N. Gibson Road, Henderson, NV 89014 Phone: +1 702 896-3337 | Fax: +1 702 896-0332

Asia Pacific Sales Office

7 Floor, No. 2, Wenhu Street, Neihu District, Taipei 114, Taiwan Phone: +886-2-2627-7655 | Fax: +886-2-2627-7792

VadaTech European Sales Office

VadaTech House, Bulls Copse Road, Southampton, SO40 9LR Phone: +44 2380 016403

info@vadatech.com | www.vadatech.com

Choose VadaTech

We are technology leaders

- · First-to-market silicon
- Constant innovation
- · Open systems expertise

We commit to our customers

- · Partnerships power innovation
- · Collaborative approach
- Mutual success

We deliver complexity

- · Complete signal chain
- System management
- Configurable solutions

We manufacture in-house

- Agile production
- · Accelerated deployment
- AS9100 accredited



Trademarks and Disclaimer

The VadaTech logo is a registered trademark of VadaTech, Inc. Other registered trademarks are the property of their respective owners. AdvancedTCA[™] and the AdvancedMC[™] logo are trademarks of the PCI Industrial Computers Manufacturers Group. All rights reserved. Specification subject to change without notice.

> © 2019 VadaTech Incorporated. All rights reserved. DOC NO. 4FM737-12 REV 01 | VERSION 1.1 – JUL/19

